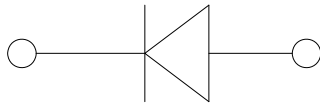
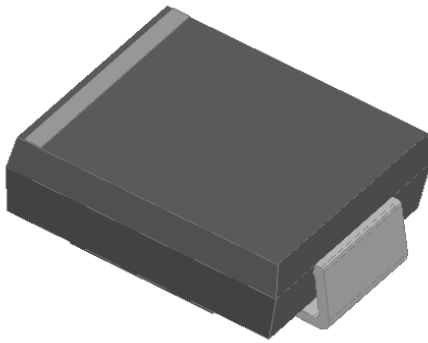


Surface Mount General Purpose Rectifier



Features

- High efficiency
- High current capability
- High reliability
- High surge current capability
- Low power loss
- Solder dip 260 °C max. 10 s, per JESD 22-B106

Mechanical Data

- **Package:** DO-214AB (SMC)
- Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** Color band denotes cathode end

■Maximum Ratings (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	GS3A	GS3B	GS3D	GS3G	GS3J	GS3K	GS3M
Device marking code			GS3A	GS3B	GS3D	GS3G	GS3J	GS3K	GS3M
Repetitive Peak Reverse Voltage	V _{RRM}	V	50	100	200	400	600	800	1000
Average Rectified Output Current @60Hz sine wave, Resistance load, T _a (FIG.1)	I _O	A	3.0						
Forward Surge Current (Non-repetitive) @ 60Hz Half-sine wave, 1 cycle, T _a =25°C	I _{FSM}	A	100						
Storage Temperature	T _{stg}	°C	-55 ~+150						
Junction Temperature	T _j	°C	-55 ~+150						

■Electrical Characteristics (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	GS3A	GS3B	GS3D	GS3G	GS3J	GS3K	GS3M
Maximum instantaneous forward voltage drop per diode	V _F	V	I _{FM} =3.0A	1.1						
Maximum DC reverse current at rated DC blocking voltage per diode	I _R	μA	T _a =25°C	5						
			T _a =100°C	50						

■Thermal Characteristics (T_a=25°C Unless otherwise specified)

PARAMETER		SYMBOL	UNIT	GS3A	GS3B	GS3D	GS3G	GS3J	GS3K	GS3M
Thermal Resistance	Junction to ambient	R _{θJ-A}	°C/W	47 ¹⁾						
	Junction to lead	R _{θJ-L}		13 ¹⁾						

Note(1)

Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.6" x 0.6" (16 mm x 16 mm) copper pad areas



GS3A THRU GS3M

■ Ordering Information (Example)

PREFERRED P/N	PACKAGE CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
GS3A~GS3M	F1	Approximate 0.248	3000	6000	42000	13" reel

■ Characteristics(Typical)

FIG.1: Io-TL Curve

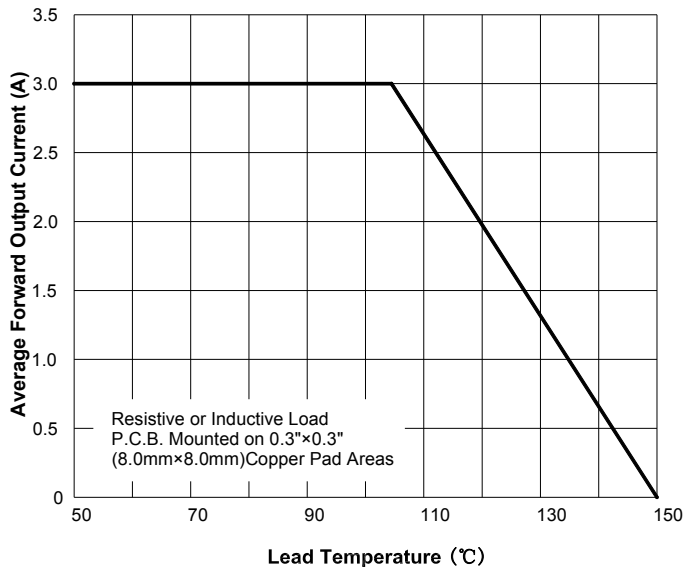


FIG.2: Forward Surge Current Capadility

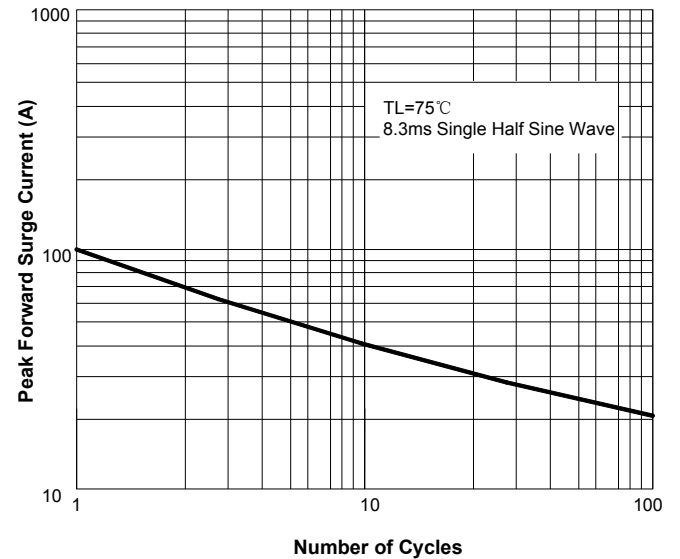


FIG.3: Forward Voltage

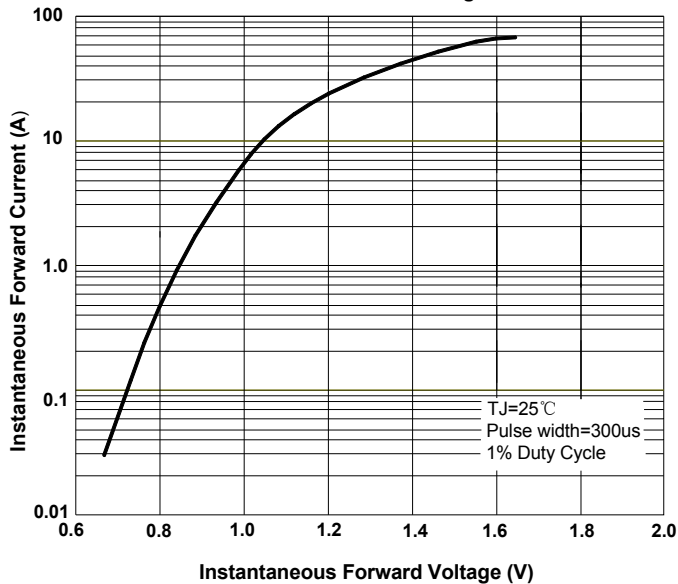
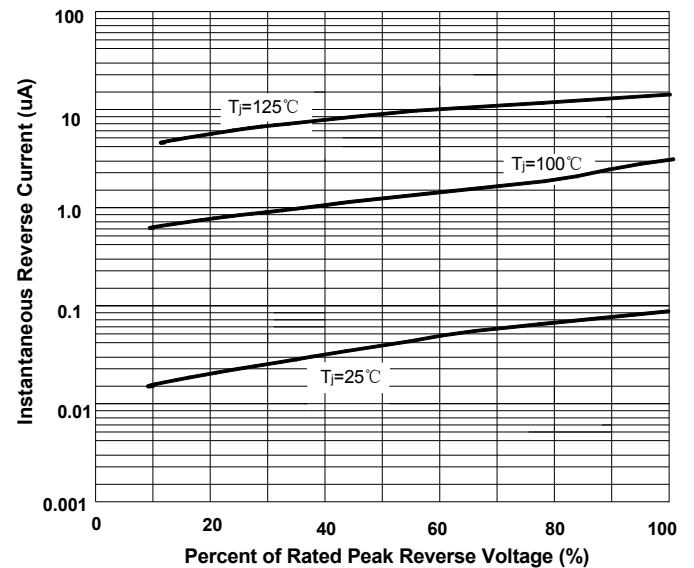
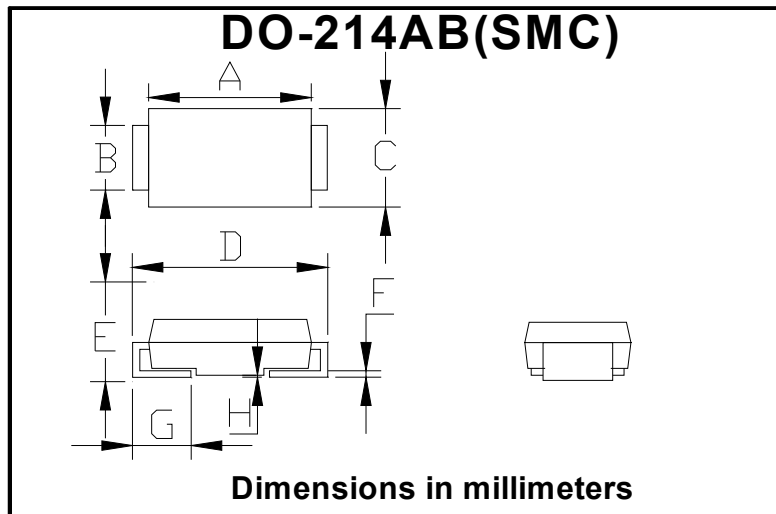


FIG.4: Typical Reverse Characteristics

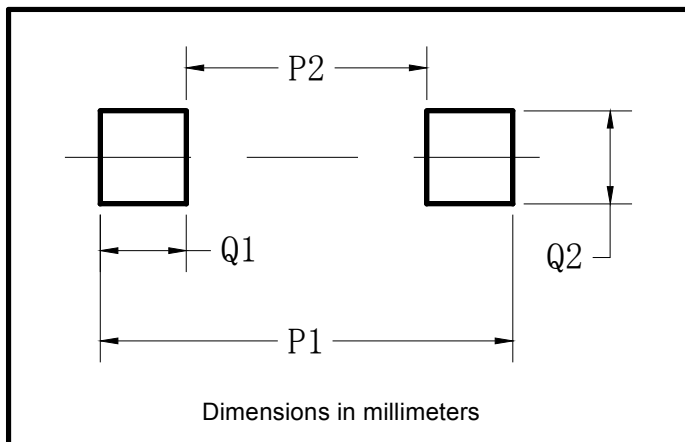


■ Outline Dimensions



DO-214AB (SMC)		
Dim	Min	Max
A	6.60	7.11
B	2.85	3.27
C	5.59	6.22
D	7.75	8.13
E	1.99	2.61
F	0.15	0.31
G	0.76	1.52
H	0.10	0.20

■ Suggested pad layout



Dim	Min
P1	9.9
P2	3.84
Q1	3.03
Q2	3.82



GS3A THRU GS3M

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